


"Half-Bridge" IGBT INT-A-PAK (Ultrafast Speed IGBT), 200 A


INT-A-PAK

FEATURES

- Generation 4 IGBT technology
- Ultrafast: Optimized for high speed 8 kHz to 40 kHz in hard switching, > 200 kHz in resonant mode
- Very low conduction and switching losses
- HEXFRED® antiparallel diodes with ultrasoft recovery
- Industry standard package
- UL approved file E78996 
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level


RoHS
COMPLIANT

PRODUCT SUMMARY

| | |
|------------------------------|--------|
| V_{CES} | 600 V |
| I_C DC | 265 A |
| $V_{CE(on)}$ at 200 A, 25 °C | 1.74 V |

BENEFITS

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, welding
- Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
|------------------------------|------------|---------------------------------|------|-------|
| Collector to emitter voltage | V_{CES} | | 600 | V |
| Continuous collector current | I_C | $T_C = 25\text{ °C}$ | 265 | A |
| | | $T_C = 67\text{ °C}$ | 200 | |
| Pulsed collector current | I_{CM} | | 400 | |
| Peak switching current | I_{LM} | | 400 | |
| Peak diode forward current | I_{FM} | | 400 | |
| Gate to emitter voltage | V_{GE} | | ± 20 | V |
| RMS isolation voltage | V_{ISOL} | Any terminal to case, t = 1 min | 2500 | |
| Maximum power dissipation | P_D | $T_C = 25\text{ °C}$ | 625 | W |
| | | $T_C = 85\text{ °C}$ | 325 | |

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|---|--------------------------------|---|------|-------|-------|-------|
| Collector to emitter breakdown voltage | $V_{BR(CES)}$ | $V_{GE} = 0\text{ V}$, $I_C = 1\text{ mA}$ | 600 | - | - | V |
| Collector to emitter voltage | $V_{CE(on)}$ | $V_{GE} = 15\text{ V}$, $I_C = 200\text{ A}$ | - | 1.74 | 2.2 | |
| | | $V_{GE} = 15\text{ V}$, $I_C = 200\text{ A}$, $T_J = 125\text{ °C}$ | - | 1.79 | 2.25 | |
| Gate threshold voltage | $V_{GE(th)}$ | $I_C = 0.25\text{ mA}$ | 3 | 4.4 | 6 | |
| Temperature coeff. of threshold voltage | $\Delta V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}$, $I_C = 0.25\text{ mA}$ | - | - 11 | - | mV/°C |
| Forward transconductance | g_{fe} | $V_{CE} = 20\text{ V}$, $I_C = 200\text{ A}$ | - | 220 | - | S |
| Collector to emitter leakage current | I_{CES} | $V_{GE} = 0\text{ V}$, $V_{CE} = 600\text{ V}$ | - | 0.014 | 1 | mA |
| | | $V_{GE} = 0\text{ V}$, $V_{CE} = 600\text{ V}$, $T_J = 125\text{ °C}$ | - | - | 10 | |
| Diode forward voltage drop | V_{FM} | $I_C = 200\text{ A}$, $V_{GE} = 0\text{ V}$ | - | 4.2 | 6.0 | V |
| | | $I_C = 200\text{ A}$, $V_{GE} = 0\text{ V}$, $T_J = 125\text{ °C}$ | - | 4.4 | 6.2 | |
| Gate to emitter leakage current | I_{GES} | $V_{GE} = \pm 20\text{ V}$ | - | - | ± 250 | nA |

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| SWITCHING CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) | | | | | | |
|---|------------------|--|------|--------|------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Total gate charge | Q_g | $I_C = 200\text{ A}$ $I_C = 270\text{ A}$ $V_{GE} = 15\text{ V}$ | - | 900 | - | nC |
| Gate to emitter charge | Q_{ge} | | - | 125 | - | |
| Gate to collector charge | Q_{gc} | | - | 306 | - | |
| Turn-on delay time | $t_{d(on)}$ | $I_C = 200\text{ A}$ $V_{CC} = 360\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $T_J = 25\text{ }^{\circ}\text{C}$ | - | 220 | - | ns |
| Rise time | t_r | | - | 154 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 300 | - | |
| Fall time | t_f | | - | 180 | - | |
| Turn-on switching energy | E_{on} | $R_{g1} = 15\text{ }\Omega$ $R_{g2} = 0\text{ }\Omega$ | - | 2.2 | - | mJ |
| Turn-off switching energy | E_{off} | | - | 6.6 | - | |
| Total switching energy | E_{ts} | | - | 8.8 | - | |
| Turn-on delay time | $t_{d(on)}$ | $I_C = 200\text{ A}$ $V_{CC} = 360\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $T_J = 125\text{ }^{\circ}\text{C}$ | - | 342 | - | ns |
| Rise time | t_r | | - | 194 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 366 | - | |
| Fall time | t_f | | - | 213 | - | |
| Turn-on switching energy | E_{on} | $R_{g1} = 15\text{ }\Omega$ $R_{g2} = 0\text{ }\Omega$ | - | 5 | - | mJ |
| Turn-off switching energy | E_{off} | | - | 16 | - | |
| Total switching energy | E_{ts} | | - | 21 | - | |
| Input capacitance | C_{ies} | $V_{GE} = 0\text{ V}$ $V_{CC} = 30\text{ V}$ $f = 1.0\text{ MHz}$ | - | 20 068 | - | pF |
| Output capacitance | C_{oes} | | - | 1254 | - | |
| Reverse transfer capacitance | C_{res} | | - | 261 | - | |
| Diode reverse recovery time | t_{rr} | $I_C = 200\text{ A}$ $V_{CC} = 360\text{ V}$ $di/dt = 1300\text{ A}/\mu\text{s}$ | - | 179 | - | ns |
| Diode peak reverse current | I_{rr} | | - | 120 | - | A |
| Diode recovery charge | Q_{rr} | | - | 10 714 | - | μC |
| Diode peak rate of fall of recovery during t_b | $di_{(rec)M}/dt$ | | - | 1922 | - | $\text{A}/\mu\text{s}$ |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | |
|--|--------------------------|------|------|------|-----------------------------|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS |
| Operating junction temperature range | T_J | - 40 | - | 150 | $^{\circ}\text{C}$ |
| Storage temperature range | T_{Stg} | - 40 | - | 125 | |
| Junction to case | R_{thJC} | - | - | 0.2 | $^{\circ}\text{C}/\text{W}$ |
| IGBT | | - | - | 0.2 | |
| Diode | R_{thCS} | - | 0.1 | - | |
| Case to sink per module | R_{thCS} | - | 0.1 | - | Nm |
| Mounting torque | case to heatsink | - | - | 4 | |
| | case to terminal 1, 2, 3 | - | - | 3 | |
| Weight | | - | 200 | - | g |

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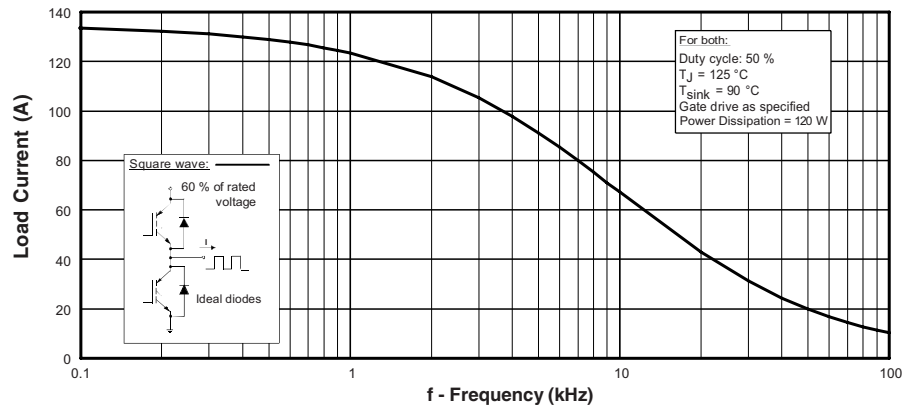


Fig. 1 - Typical Load Current vs. Frequency
(Load Current = I_{RMS} of Fundamental)

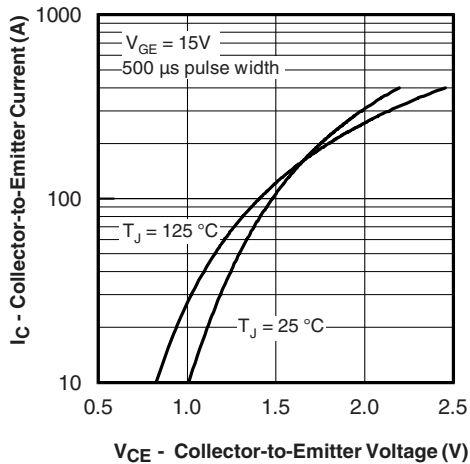


Fig. 2 - Typical Output Characteristics

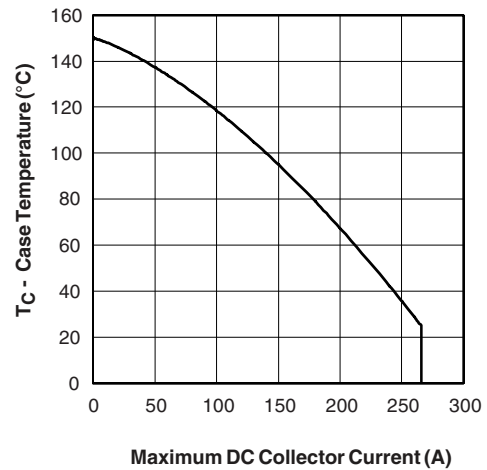


Fig. 4 - Case Temperature vs. Maximum Collector Current

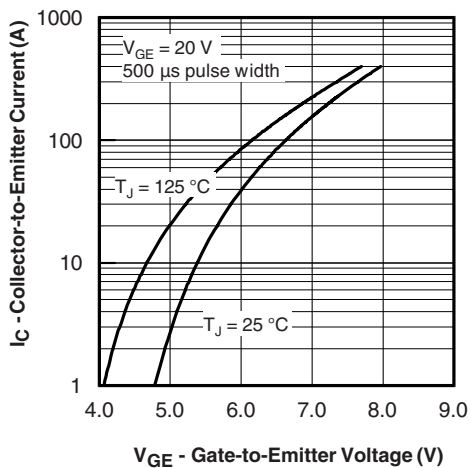


Fig. 3 - Typical Transfer Characteristics

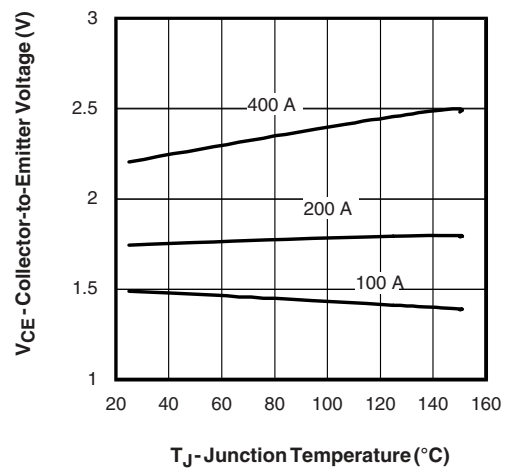


Fig. 5 - Typical Collector to Emitter Voltage vs.
Junction Temperature

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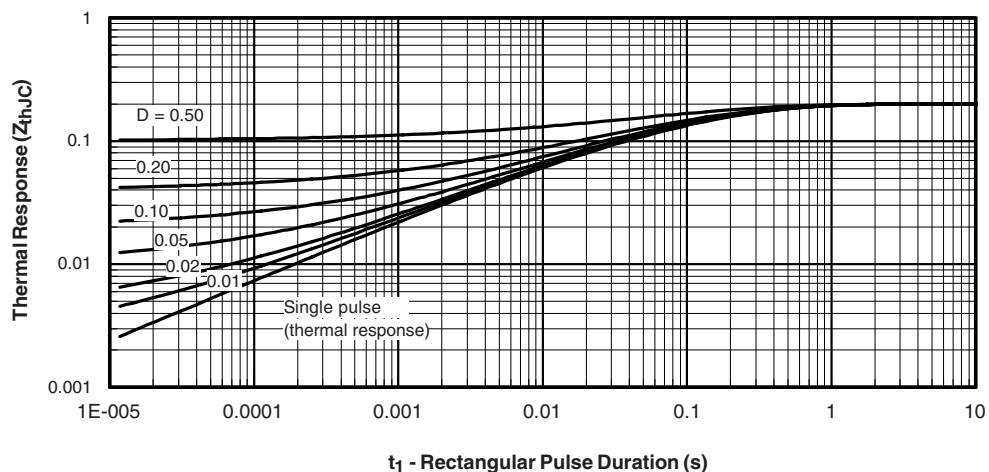
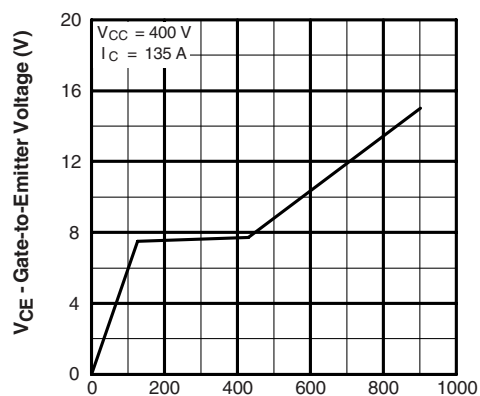
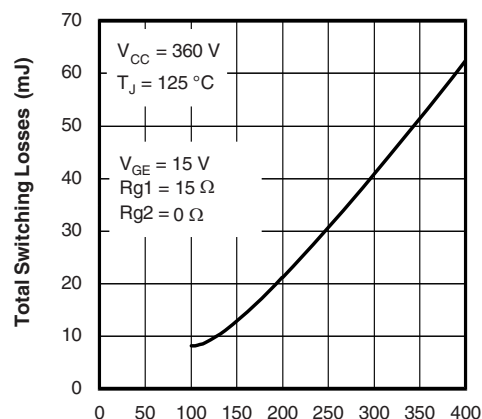


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case



Q_G - Total gate Charge (nC)

Fig. 7 - Typical Gate Charge vs. Gate to Emitter Voltage



I_C - Collector-to-Emitter Current (A)

Fig. 9 - Typical Switching Losses vs. Collector to Emitter Current

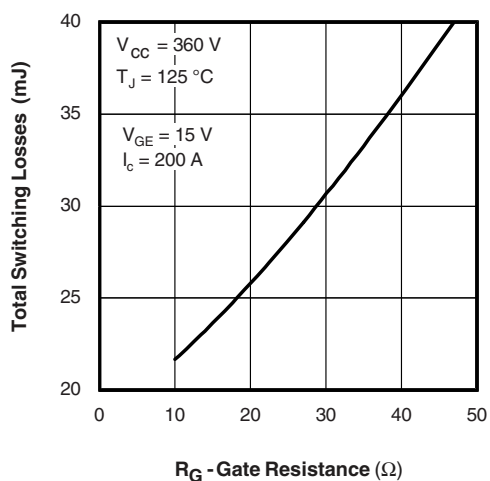


Fig. 8 - Typical Switching Losses vs. Gate Resistance

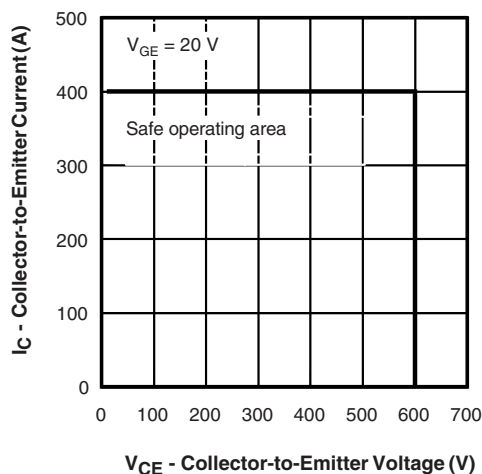
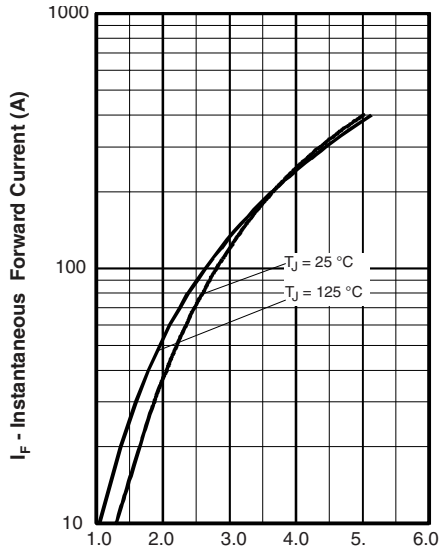


Fig. 10 - Reverse Bias SOA

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V_{FM} - Forward Voltage Drop (V)

Fig. 11 - Typical Forward Voltage Drop vs. Instantaneous Forward Current

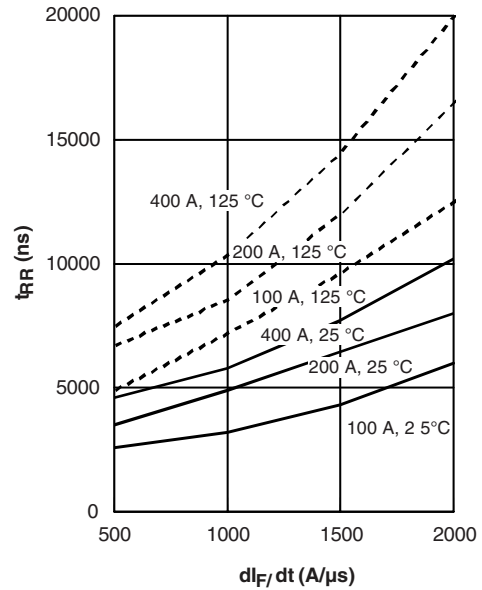


Fig. 13 - Typical Reverse Recovery Time vs. dI_F/dt

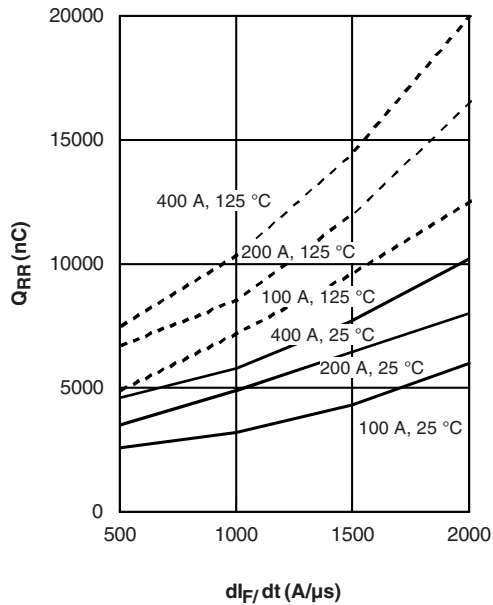


Fig. 12 - Typical Stored Charge vs. dI_F/dt

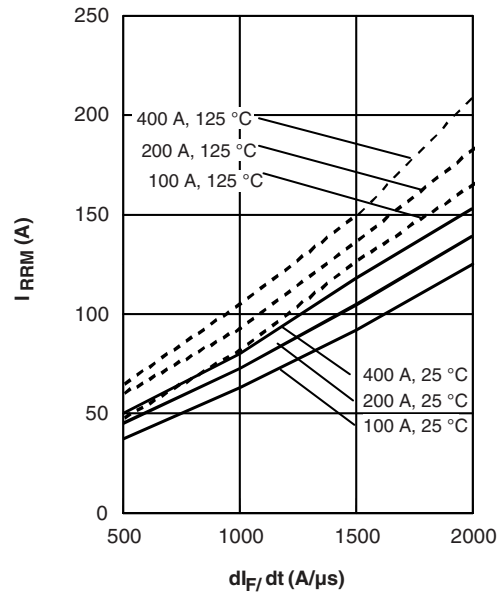


Fig. 14 - Typical Reverse Recovery vs. dI_F/dt

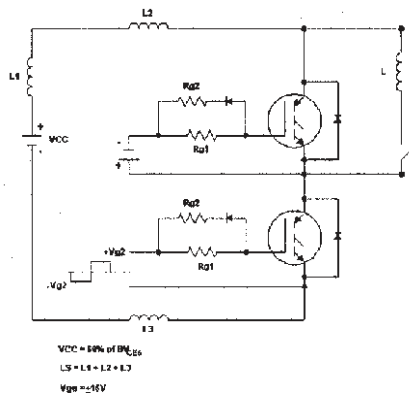


Fig. 15a - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off}(\text{diode})$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

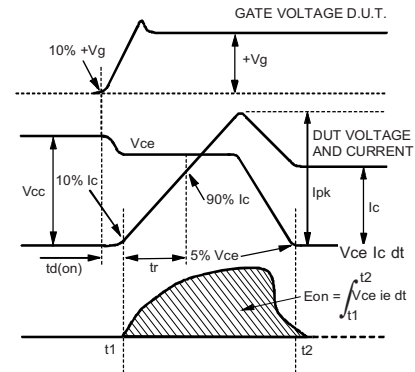


Fig. 15c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on} , $t_{d(on)}$, t_r

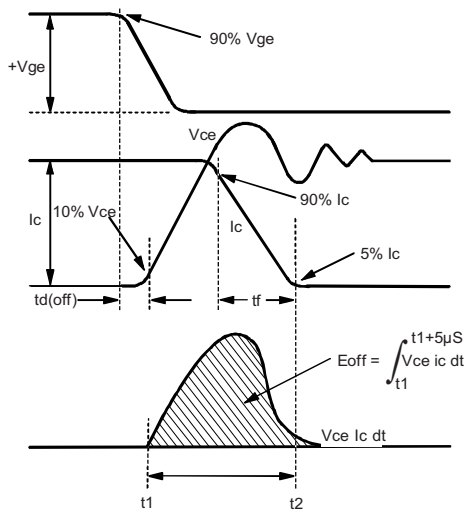


Fig. 15b - Test Waveforms for Circuit of Fig. 18a, Defining E_{off} , $t_{d(off)}$, t_f

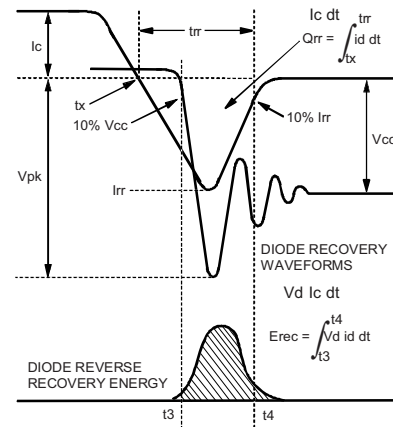


Fig. 15d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

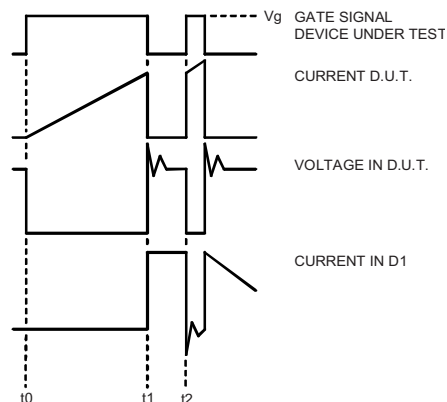


Fig. 15e - Macro Waveforms for Figure 18a's Test Circuit

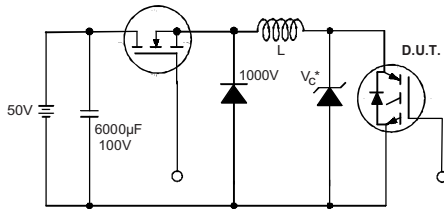


Fig. 16 - Clamped Inductive Load Test Circuit

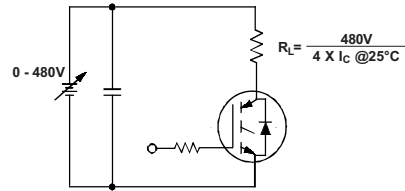


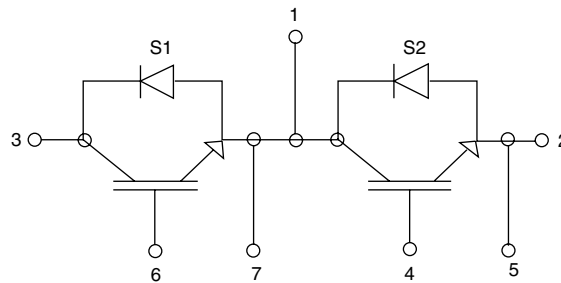
Fig. 17 - Pulsed Collector Current Test Circuit

ORDERING INFORMATION TABLE

| Device code | GA | 200 | T | S | 60 | U | PbF |
|-------------|----|-----|---|---|----|---|-----|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 |

- 1 - Essential part number IGBT modules
- 2 - Current rating (200 = 200 A)
- 3 - Circuit configuration (T = Half bridge)
- 4 - INT-A-PAK
- 5 - Voltage code (60 = 600 V)
- 6 - Speed/type (U = Ultrafast IGBT)
- 7 - PbF = Lead (Pb)-free

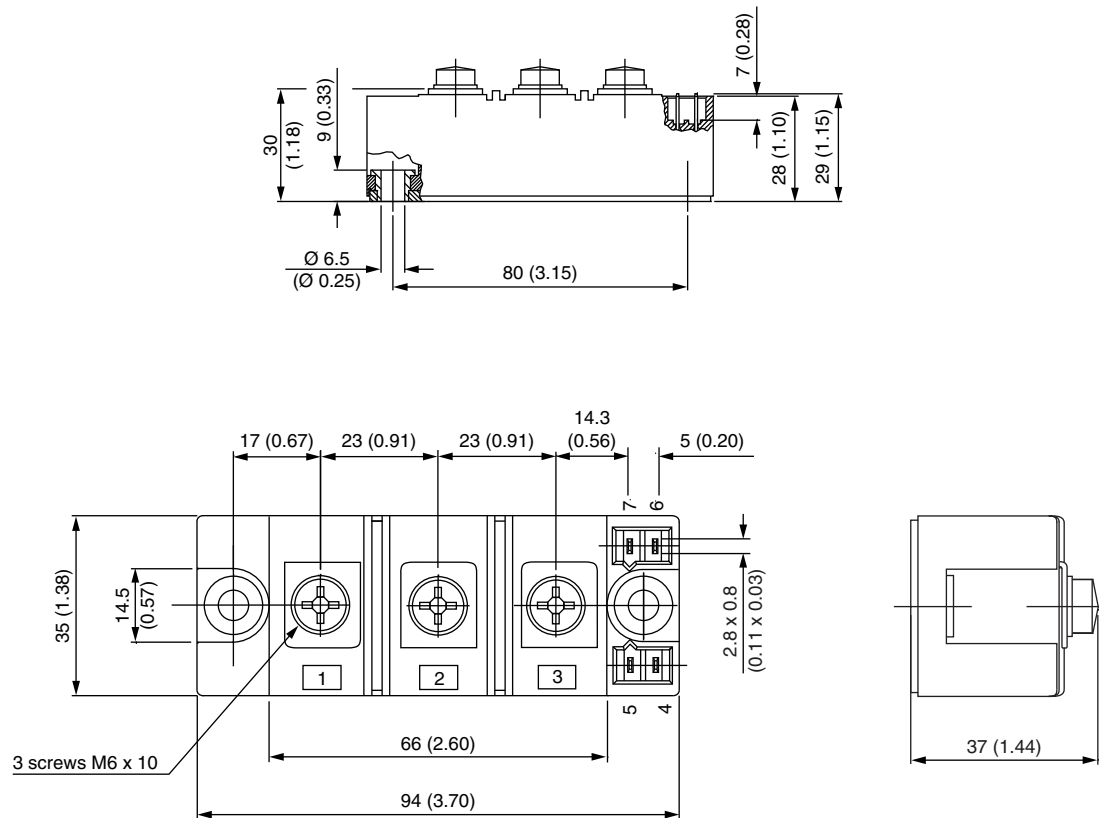
CIRCUIT CONFIGURATION



| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?95173 |

INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)





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